

## FQH44N10-VB Datasheet

## N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V <sub>(BR)DSS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)
100	0.035 at V <sub>GS</sub> = 10 V	85

#### FEATURES

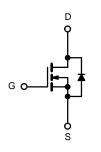
- TrenchFET<sup>®</sup> Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R<sub>g</sub> Tested

#### APPLICATIONS

• Isolated DC/DC Converters



**TO-247AC** 



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>C</sub> = 25 °C, unless oth	erwise noted		
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	100	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
Continuous Drain Current ( $T_1 = 175 ^{\circ}C$ )	T <sub>C</sub> = 25 °C		85	
Continuous Drain Current $(T_j = T/5 C)$	T <sub>C</sub> = 125 °C	I <sub>D</sub>	60	A
Pulsed Drain Current		I <sub>DM</sub>	150	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	39	
Single Pulse Avalanche Energy <sup>b</sup>	L = 0.1 mm	E <sub>AS</sub>	61	mJ
	T <sub>C</sub> = 25 °C	P	375 <sup>c</sup>	201
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C <sup>d</sup>	- P <sub>D</sub> -	3.75	W
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE RA	TINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount	R <sub>thJA</sub>	40	°C/W
Junction-to-Case (Drain)	·	R <sub>thJC</sub>	0.4	0/11

Notes:

a. Package limited.

b. Duty cycle  $\leq$  1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				•		
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 V, I_{D} = 250 \mu A$	100			V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1		3	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			50	μA
		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$		250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40			А
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.035		
	r <sub>DS(on)</sub>	$V_{GS}$ = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C		0.063		Ω
		$V_{GS}$ = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C		0.084		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	25			S
Dynamic <sup>b</sup>	•					
Input Capacitance	C <sub>iss</sub>			5100		
Output Capacitance	C <sub>oss</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 25 V, f = 1 MHz		480		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			210		
Total Gate Charge <sup>c</sup>	Qg			90		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS}$ = 100 V, $V_{GS}$ = 10 V, $I_{D}$ = 65 A		23		nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			34		
Gate Resistance	Rg		0.5	1.7	3.3	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			24	35	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 100 V, R <sub>L</sub> = 1.5 $\Omega$		220	330	20
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$\rm I_D \cong 65$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 2.5 $\Omega$		45	70	ns
Fall Time <sup>c</sup>	t <sub>f</sub>			200	300	
Source-Drain Diode Ratings and Cha	aracteristics 7	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$				
Continuous Current	ا <sub>S</sub>			85		۸
Pulsed Current	I <sub>SM</sub>			150		A
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 65 A, V <sub>GS</sub> = 0 V		1.0	1.5	V
Reverse Recovery Time	t <sub>rr</sub>			130	200	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 50 A, di/dt = 100 A/µs		8	12	Α
Reverse Recovery Charge	Q <sub>rr</sub>			0.52	1.2	μC

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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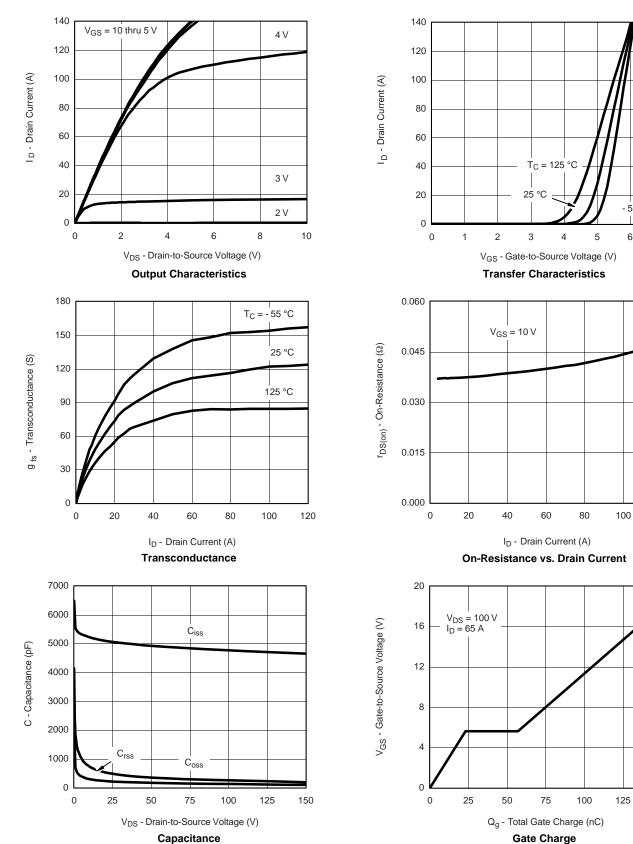


- 55 °C

7

120

6

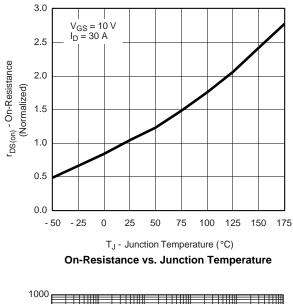


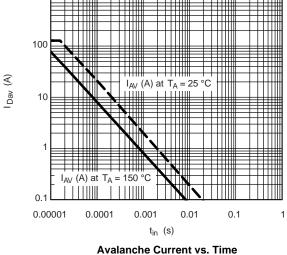
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

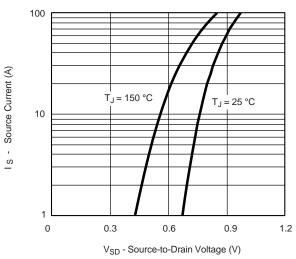
150



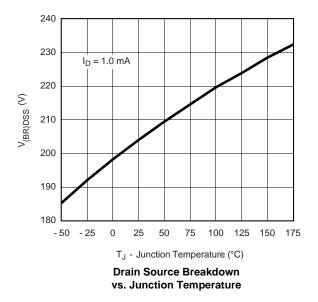
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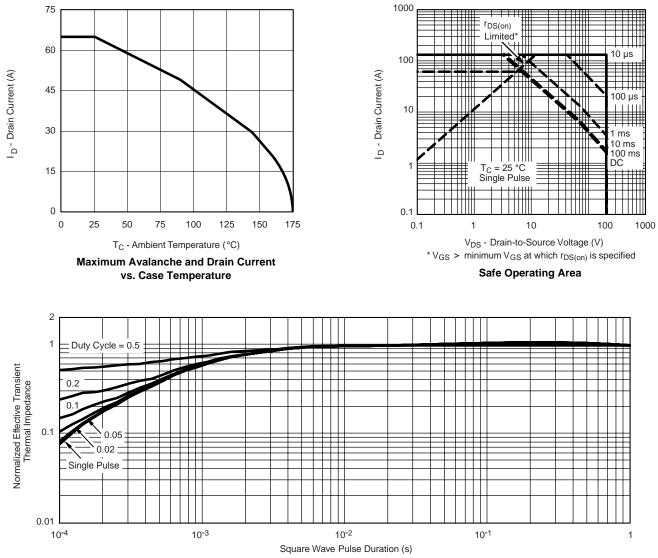
Source-Drain Diode Forward Voltage



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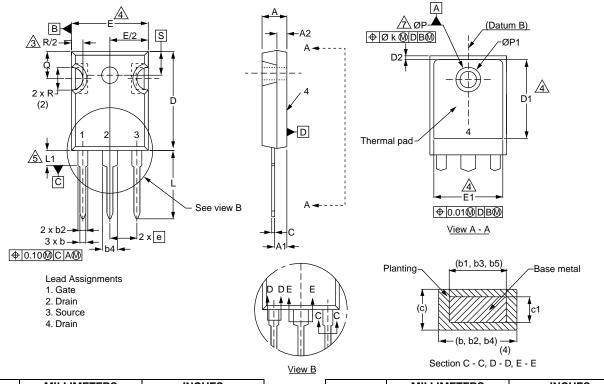
#### **THERMAL RATINGS**



Normalized Thermal Transient Impedance, Junction-to-Case



**TO-247AC** 



	MILLIMETERS		IS INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
Е	15.29	15.87	0.602	0.625
E1	13.72	-	0.540	-
е	5.46	5.46 BSC		5 BSC
Øk	0.2	0.254		010
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
Ν	7.62	7.62 BSC		) BSC
ØР	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51 BSC		0.217 BSC	



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